

Nctes:

1: Current is limited by bond vire configuration.

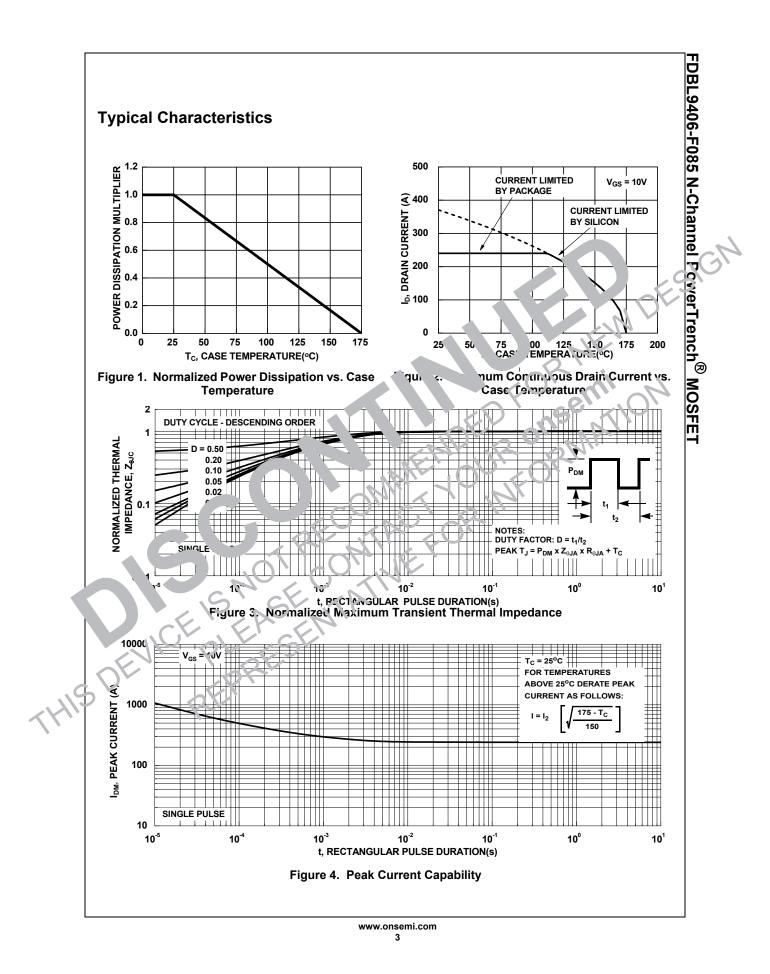
2: Starting $T_J = 25^{\circ}C$, L = 0.1 mH, $I_{AS} = 79.5 \text{A}$, $V_{DD} = 40 \text{V}$ during inductor charging and $V_{DD} = 0 \text{V}$ during time in avalanche.

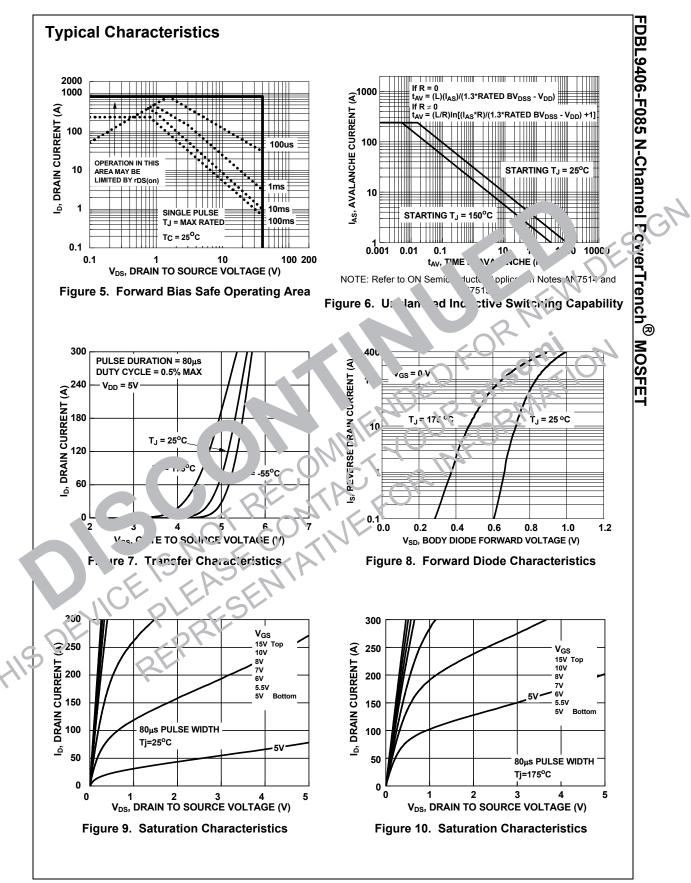
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

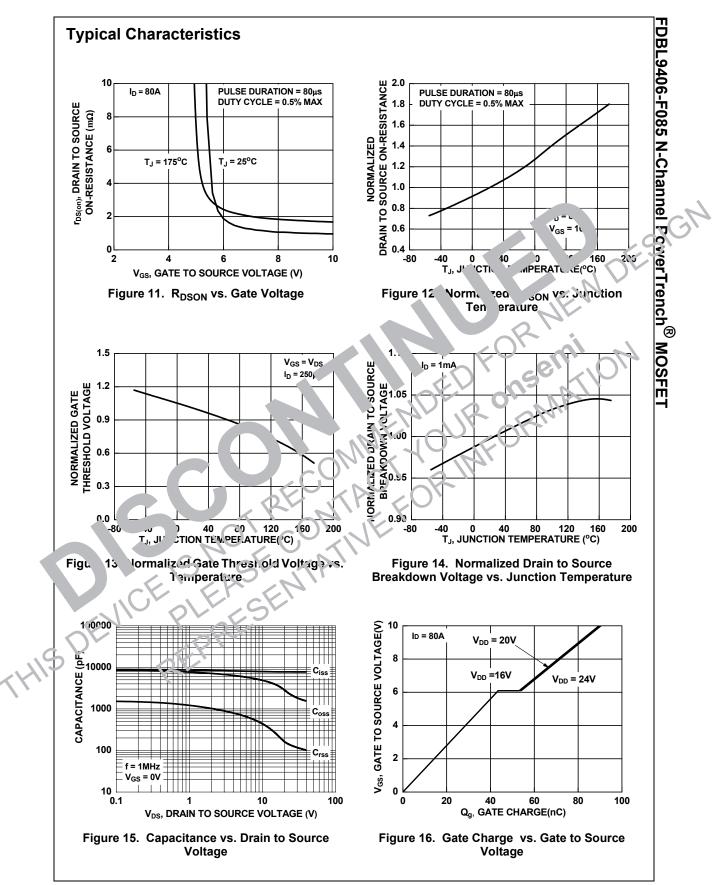
Device Marking	Device	Package			
FDBL9406	FDBL9406-F085	MO-299A	-	-	-

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V_{DS} =40V, T_{J} = 25°C V_{GS} = 0V T_{J} = 175°C (Note 4	-	-	1	μA mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.0	3 ^		V
R _{DS(on)}	Drain to Source On Resistance	$I_{\rm D} = 80$ A, $T_{\rm J} = 25^{\rm o}$ C	-	0.	1.2	mΩ
D3(01)		V_{GS} = 10V T _J = 175°C (Note 4	<u>.)</u>	1.64	1.8	mΩ
Dynami	c Characteristics					D'
C _{iss}	Input Capacitance		\top	735	K - 1	pF
C _{oss}	Output Capacitance	──V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		216.1	-	pF
C _{rss}	Reverse Transfer Capacitance			29	÷.	pF
R _g	Gate Resistance	f = 1MH-	<u> </u>	2.5		Q
Q _{g(ToT)}	Total Gate Charge at 10V	V_c) to 10 $D = 32^{1/2}$	TX -	90	107	21
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 2V$ $I_D = 80A$		10 5	15.5	nC
Q _{gs}	Gate-to-Source Gate Charge		- 0	43		nC
Q _{gd}	Gate-to-Drain "Miller" Charge		2	10	- 1	nC
Switchi	ng Characteristic	MME OU	<u>FC</u>		102	ns
	Turn-On [lay		f _	33	-	ns
t _{d(on)} t _r	P' "me	$V_{DD} = 20V, I_D = 8CA,$	-	40	_	ns
t _{d(off)}		$V_{DD} = 200, T_D = 0.5A,$ $V_{5C} = 10V, R_{GEN} = 6\Omega$	-	40	_	ns
t _f			-	23	-	ns
4			-	-	91	ns
Drai, S	o ce Dicoe Characteristics	TAT				
	Source-to-Drain Dicue Voltage	I _{SD} =80A, V _{GS} = 0V	-	-	1.25	V
		I _{SD} = 40A, V _{GS} = 0V	-	-	1.2	V
tr	Reverse-Recovery initia	I _F = 80A, dI _{SD} /dt = 100A/μs,	-	91	107	ns
O _{rr}	Reverse-Recovery Charge	V _{DD} =32V	-	128	167	nC
Note:	26					





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